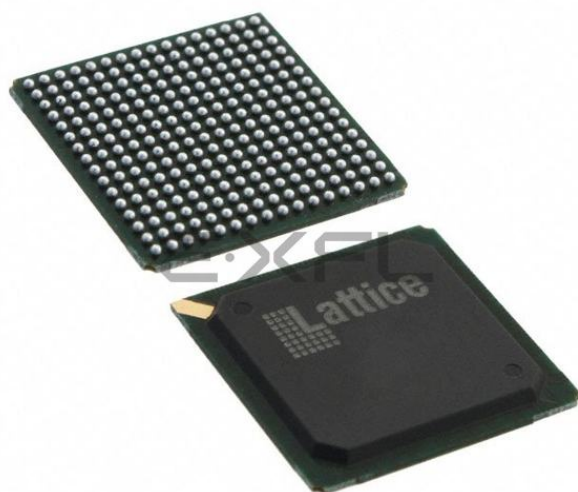




Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	1500
Number of Logic Elements/Cells	12000
Total RAM Bits	226304
Number of I/O	193
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-12e-6f256i

Figure 2-1. Simplified Block Diagram, ECP2-6 Device (Top Level)

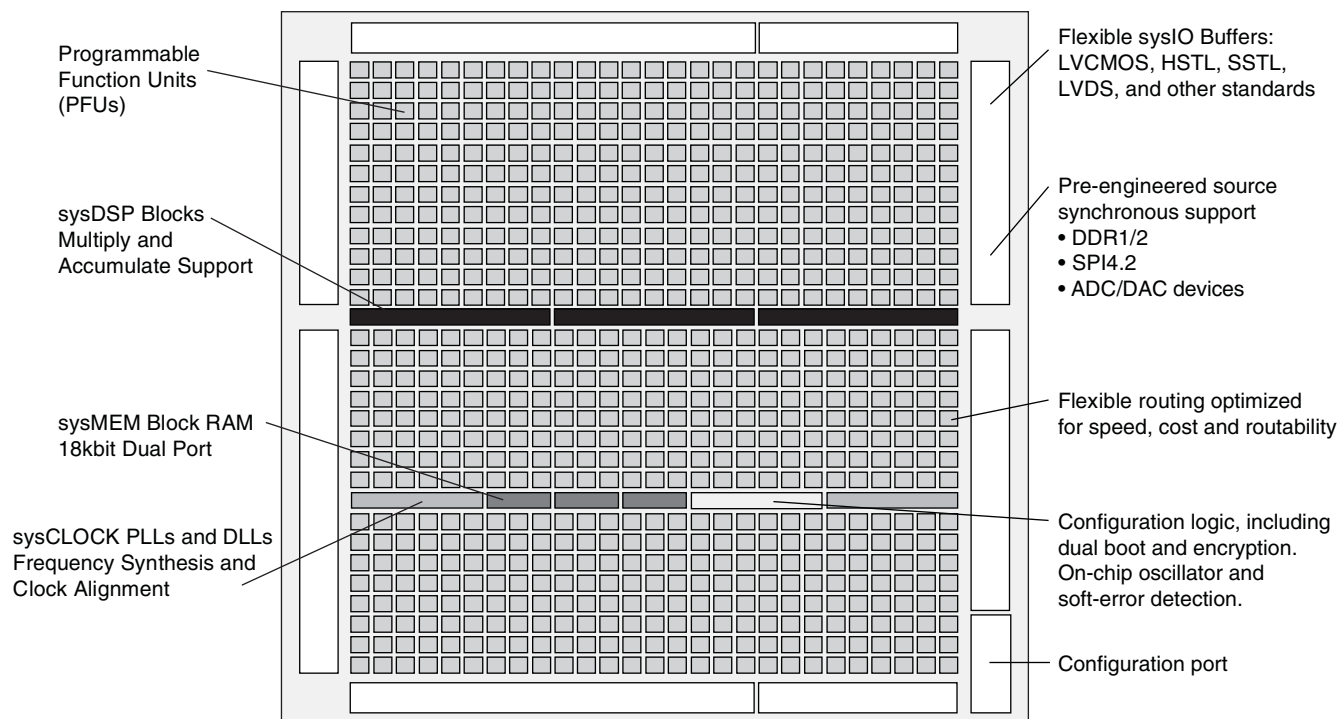
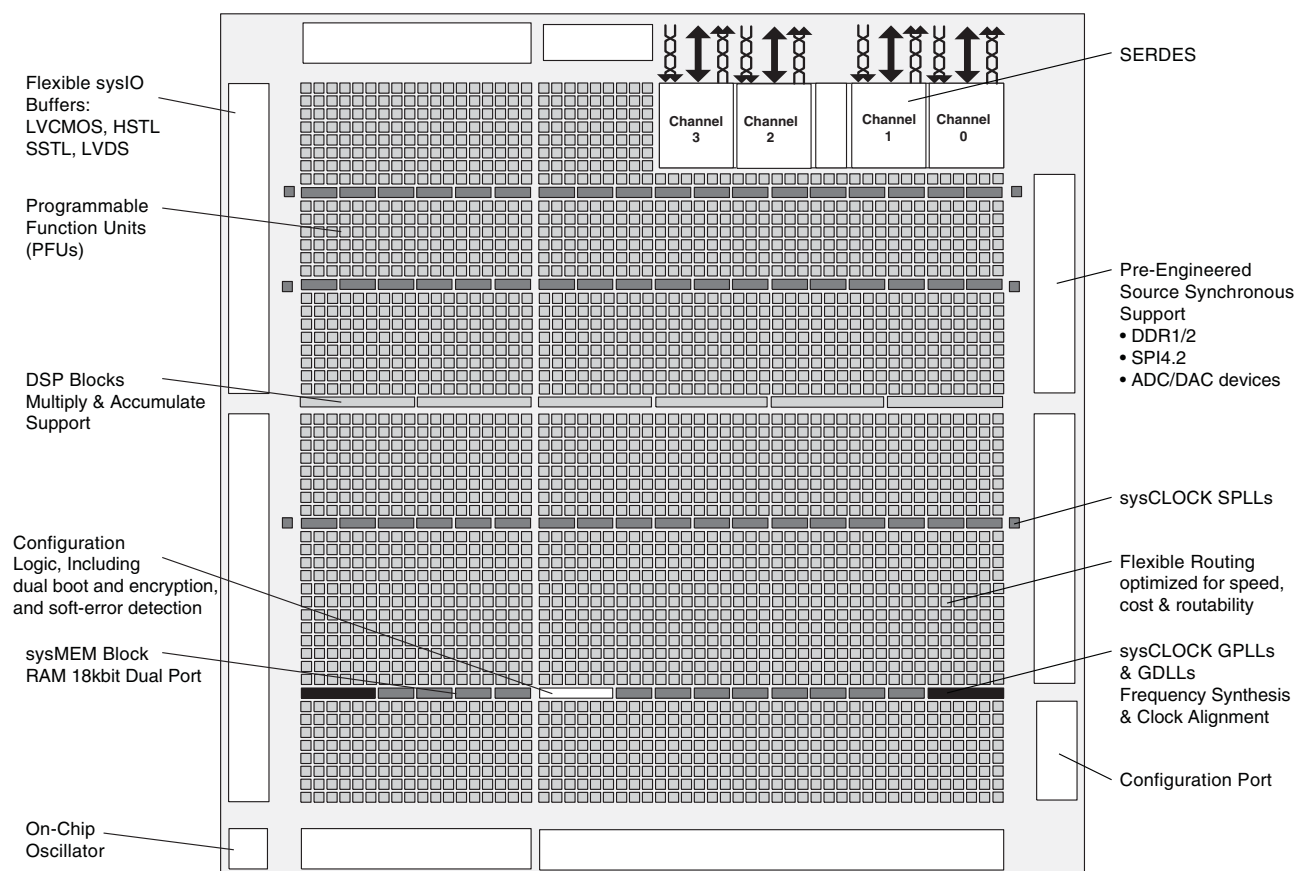


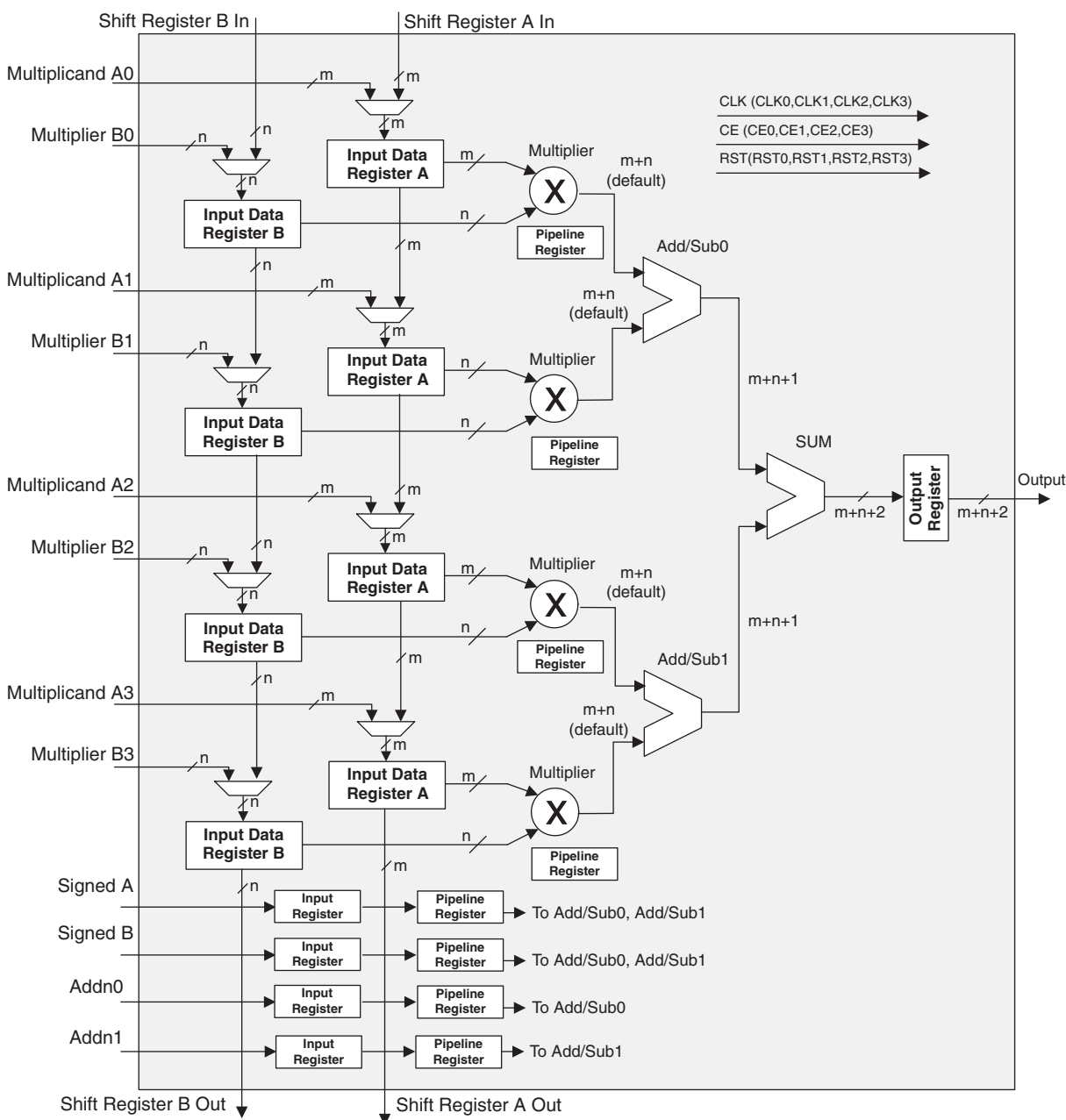
Figure 2-2. Simplified Block Diagram, ECP2M20 Device (Top Level)



MULTADDSUBSUM sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and B1. Additionally the operands A2 and B2 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A3 and B3. The result of both addition/subtraction are added in a summation block. The user can enable the input, output and pipeline registers. Figure 2-26 shows the MULTADDSUBSUM sysDSP element.

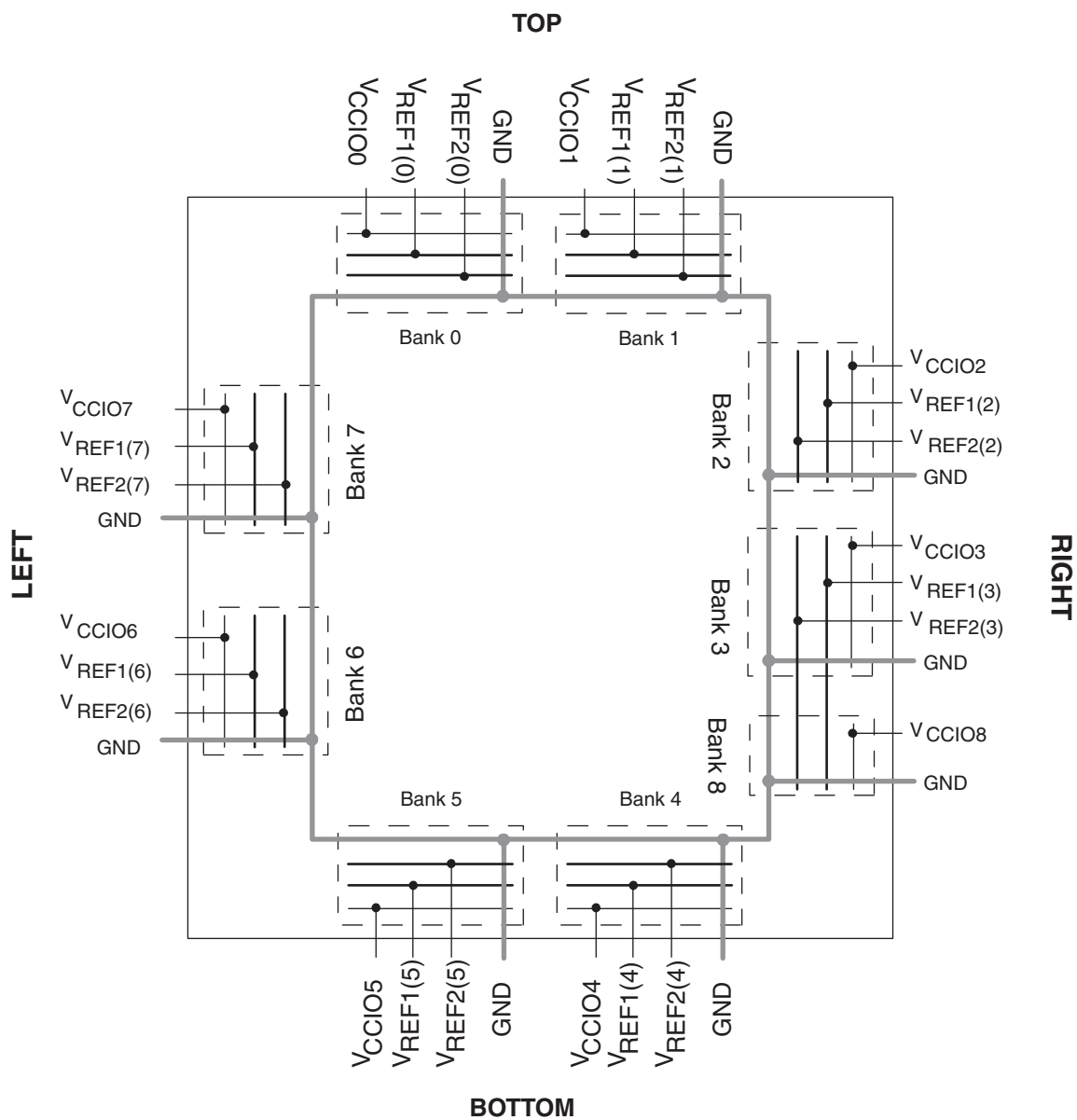
Figure 2-26. MULTADDSUBSUM



Clock, Clock Enable and Reset Resources

Global Clock, Clock Enable and Reset signals from routing are available to every DSP block. Four Clock, Reset and Clock Enable signals are selected for the sysDSP block. From four clock sources (CLK0, CLK1, CLK2, CLK3)

Figure 2-37. LatticeECP2 Banks





LatticeECP2/M Family Data Sheet

DC and Switching Characteristics

September 2013

Data Sheet DS1006

Absolute Maximum Ratings^{1, 2, 3}

Supply Voltage V_{CC} -0.5 to 1.32V

Supply Voltage V_{CCAUX} -0.5 to 3.75V

Supply Voltage V_{CCJ} -0.5 to 3.75V

Output Supply Voltage V_{CCIO} -0.5 to 3.75V

Input or I/O Tristate Voltage Applied⁴ -0.5 to 3.75V

Storage Temperature (Ambient) -65 to 150°C

Junction Temperature (T_j) +125°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice [Thermal Management](#) document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to ($V_{IHMAX} + 2$) volts is permitted for a duration of <20ns.

Recommended Operating Conditions⁷

Symbol	Parameter	Min.	Max.	Units
$V_{CC}^{1, 4, 5}$	Core Supply Voltage	1.14	1.26	V
$V_{CCAUX}^{1, 3, 4, 5}$	Auxiliary Supply Voltage	3.135	3.465	V
V_{CCPLL}	PLL Supply Voltage	1.14	1.26	V
$V_{CCIO}^{1, 2, 4}$	I/O Driver Supply Voltage	1.14	3.465	V
V_{CCJ}^1	Supply Voltage for IEEE 1149.1 Test Access Port	1.14	3.465	V
t_{JCOM}	Junction Temperature, Commercial Operation	0	85	°C
t_{JIND}	Junction Temperature, Industrial Operation	-40	100	°C
SERDES External Power Supply (For LatticeECP2M Family Only)				
V_{CCIB}	Input Buffer Power Supply (1.2V)	1.14	1.26	V
	Input Buffer Power Supply (1.5V)	1.425	1.575	V
V_{CCOB}	Output Buffer Power Supply (1.2V)	1.14	1.26	V
	Output Buffer Power Supply (1.5V)	1.425	1.575	V
$V_{CCAUX33}$	Termination Resistor Switching Power Supply	3.135	3.465	V
V_{CCR}^6	Receive Power Supply	1.14	1.26	V
V_{CCT}^6	Transmit Power Supply	1.14	1.26	V

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

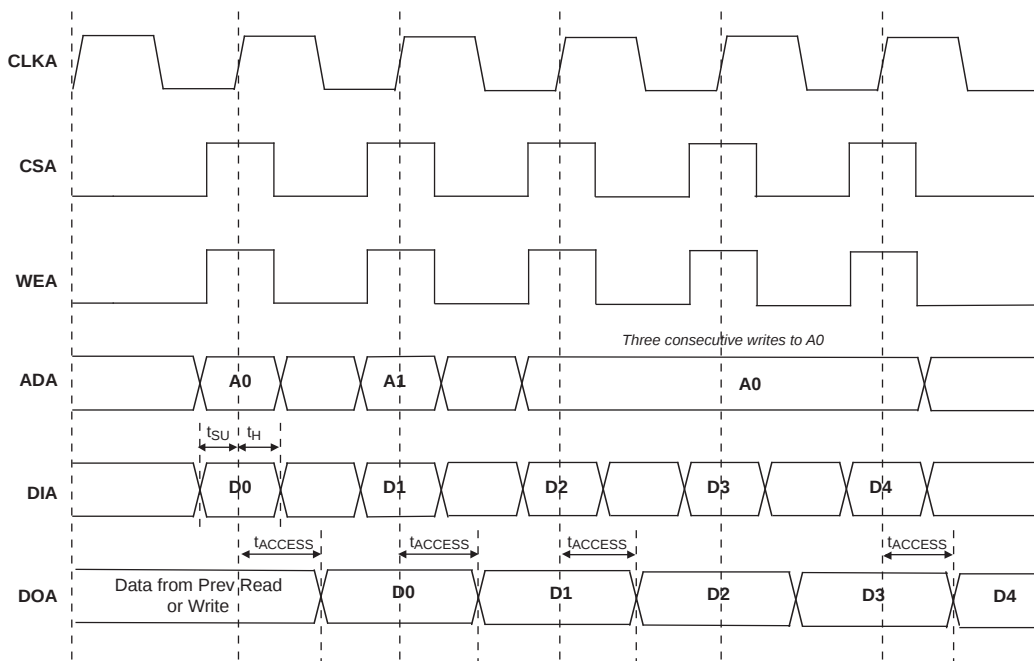
Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{SU_DEL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.40	—	1.70	—	1.90	—	ns
		LFE2-12	1.40	—	1.70	—	1.90	—	ns
		LFE2-20	1.40	—	1.70	—	1.90	—	ns
		LFE2-35	1.40	—	1.70	—	1.90	—	ns
		LFE2-50	1.40	—	1.70	—	1.90	—	ns
		LFE2-70	1.40	—	1.70	—	1.90	—	ns
		LFE2M20	1.40	—	1.70	—	1.90	—	ns
		LFE2M35	1.40	—	1.70	—	1.90	—	ns
		LFE2M50	1.40	—	1.70	—	1.90	—	ns
		LFE2M70	1.40	—	1.70	—	1.90	—	ns
		LFE2M100	1.40	—	1.70	—	1.90	—	ns
t _{H_DEL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
f _{MAX_IO}	Clock Frequency of I/O Register and PFU Register	ECP2/M	—	420	—	357	—	311	MHz
General I/O Pin Parameters (using Edge Clock without PLL)¹									
t _{COE}	Clock to Output - PIO Output Register	LFE2-6	—	2.60	—	2.90	—	3.20	ns
		LFE2-12	—	2.60	—	2.90	—	3.20	ns
		LFE2-20	—	2.60	—	2.90	—	3.20	ns
		LFE2-35	—	2.60	—	2.90	—	3.20	ns
		LFE2-50	—	2.60	—	2.90	—	3.20	ns
		LFE2-70	—	2.60	—	2.90	—	3.20	ns
		LFE2M20	—	2.60	—	2.90	—	3.20	ns
		LFE2M35	—	2.60	—	2.90	—	3.20	ns
		LFE2M50	—	3.10	—	3.40	—	3.70	ns
		LFE2M70	—	3.10	—	3.40	—	3.70	ns
		LFE2M100	—	3.10	—	3.40	—	3.70	ns

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t_{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f_{MAX_DDR2}	DDR Clock Frequency	ECP2/M	133	266	133	200	133	166	MHz
SPI4.2 I/O Pin Parameters Static Alignment^{4, 8, 11}									
	Maximum Data Rate	ECP2-20	—	750	—	622	—	622	Mbps
		ECP2-35	—	750	—	622	—	622	Mbps
		ECP2-50	—	750	—	622	—	622	Mbps
		ECP2-70	—	750	—	622	—	622	Mbps
		ECP2M20	—	622	—	622	—	622	Mbps
		ECP2M35	—	622	—	622	—	622	Mbps
		ECP2M50	—	622	—	622	—	622	Mbps
		ECP2M70	—	622	—	622	—	622	Mbps
		ECP2M100	—	622	—	622	—	622	Mbps
$t_{DVACLKSPI}$	Data Valid After CLK (Receive)	ECP2-20	—	0.25	—	0.25	—	0.25	UI
		ECP2-35	—	0.25	—	0.25	—	0.25	UI
		ECP2-50	—	0.25	—	0.25	—	0.25	UI
		ECP2-70	—	0.25	—	0.25	—	0.25	UI
		ECP2M20	—	0.21	—	0.21	—	0.21	UI
		ECP2M35	—	0.21	—	0.21	—	0.21	UI
		ECP2M50	—	0.21	—	0.21	—	0.21	UI
		ECP2M70	—	0.21	—	0.21	—	0.21	UI
		ECP2M100	—	0.21	—	0.21	—	0.21	UI
$t_{DVECLKSPI}$	Data Hold After CLK (Receive)	ECP2-20	0.75	—	0.75	—	0.75	—	UI
		ECP2-35	0.75	—	0.75	—	0.75	—	UI
		ECP2-50	0.75	—	0.75	—	0.75	—	UI
		ECP2-70	0.75	—	0.75	—	0.75	—	UI
		ECP2M20	0.79	—	0.79	—	0.79	—	UI
		ECP2M35	0.79	—	0.79	—	0.79	—	UI
		ECP2M50	0.79	—	0.79	—	0.79	—	UI
		ECP2M70	0.79	—	0.79	—	0.79	—	UI
		ECP2M100	0.79	—	0.79	—	0.79	—	UI
t_{DIASPI}	Data Invalid After Clock (Transmit)	ECP2-20	—	280	—	280	—	280	ps
		ECP2-35	—	280	—	280	—	280	ps
		ECP2-50	—	280	—	280	—	280	ps
		ECP2-70	—	280	—	280	—	280	ps
		ECP2M20	—	230	—	230	—	230	ps
		ECP2M35	—	230	—	230	—	230	ps
		ECP2M50	—	230	—	230	—	230	ps
		ECP2M70	—	230	—	230	—	230	ps
		ECP2M100	—	230	—	230	—	230	ps

Figure 3-11. Write Through (SP Read/Write on Port A, Input Registers Only)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

sysCLOCK SPLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f _{IN}	Input Clock Frequency (CLKI, CLKFB)	Without external capacitor	33	—	420	MHz
		With external capacitor ^{5, 6}	2	—	420	MHz
f _{OUT}	Output Clock Frequency (CLKOP, CLKOS)	Without external capacitor	33	—	420	MHz
		With external capacitor ⁵	5	—	50	MHz
f _{OUT2}	K-Divider Output Frequency (CLKOK)	Without external capacitor	0.258	—	210	MHz
		With external capacitor ⁵	0.039	—	25	MHz
f _{VCO}	PLL VCO Frequency		640	—	1280	MHz
f _{PFD}	Phase Detector Input Frequency	Without external capacitor	33	—	420	MHz
		With external capacitor ⁶	2	—	50	MHz
AC Characteristics						
t _{DT}	Output Clock Duty Cycle	Default Duty Cycle Selected ³	45	50	55	%
t _{PH} ⁴	Output Phase Accuracy		—	—	±0.05	UI
t _{OPJIT} ¹	Output Clock Period Jitter	f _{OUT} ≥ 100 MHz	—	—	±125	ps
		50 ≤ f _{OUT} < 100 MHz	—	—	0.025	UIPP
		f _{OUT} < 50 MHz	—	—	0.04	UIPP
t _{SK}	Input Clock to Output Clock Skew	Divider Ratio = Integer	—	—	±250	ps
t _W	Output Clock Pulse Width	At 90% or 10%	1	—	—	ns
t _{LOCK} ²	PLL Lock-in Time	Without external capacitor	—	—	150	μs
		With external capacitor ⁵	—	—	500	μs
t _{IPJIT}	Input Clock Period Jitter		—	—	±200	ps
t _{FBKDLY}	External Feedback Delay		—	—	10	ns
t _{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t _{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t _{RST}	RST Pulse Width (RSTK)		15	—	—	ns
	Reset Signal Pulse Width (RST)	Without external capacitor	500	—	—	ns
		With external capacitor ⁵	20	—	—	μs

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.
2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.
3. Using LVDS output buffers.
4. Phase accuracy of CLKOS compared to CLKOP.
5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.
6. $f_{OUT}(\text{max}) = f_{IN} * 10$ for $f_{IN} < 5$ MHz.

DLL Timing

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
f_{REF}	Input reference clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{FB}	Feedback clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{CLKOP}^1	Output clock frequency, CLKOP	100	—	500	MHz
f_{CLKOS}^2	Output clock frequency, CLKOS	25	—	500	MHz
t_{PJIT}	Output clock period jitter (clean input)		—	250	ps p-p
t_{CYJIT}	Output clock cycle to cycle jitter (clean input)			250	ps p-p
t_{DUTY}	Output clock duty cycle (at 50% levels, 50% duty cycle input clock, 50% duty cycle circuit turned off, time reference delay mode)	35		65	%
$t_{DUTYTRD}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, time reference delay mode)	40		60	%
$t_{DUTYCIR}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, clock injection removal mode)	40		60	%
t_{SKEW}^3	Output clock to clock skew between two outputs with the same phase setting	—	—	100	ps
t_{PWH}	Input clock minimum pulse width high (at 80% level)	750	—	—	ps
t_{PWL}	Input clock minimum pulse width low (at 20% level)	750	—	—	ps
t_{INSTB}	Input clock period jitter	—	—	+/-250	ps
t_{LOCK}	DLL lock time	18,500	—	—	cycles
t_{RSWD}	Digital reset minimum pulse width (at 80% level)	3	—	—	ns
t_{PA}	Delay step size	16.5	42	59.4	ps
t_{RANGE1}	Max. delay setting for single delay block (144 taps)	2.376	6	8.553	ns
t_{RANGE4}	Max. delay setting for four chained delay blocks	9.504	24	34.214	ns

1. CLKOP runs at the same frequency as the input clock.

2. CLKOS minimum frequency is obtained with divide by 4.

3. This is intended to be a “path-matching” design guideline and is not a measurable specification.

LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35 (Cont.)

Pin Type		LFE2-20				LFE2-35	
		208 PQFP	256 fpBGA	484 fpBGA	672 fpBGA	484 fpBGA	672 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0
	Bank2	0	1	2	2	2	3
	Bank3	0	0	0	2	0	2
	Bank4	0	2	3	3	3	3
	Bank5	0	1	3	4	3	4
	Bank6	0	1	2	3	1	3
	Bank7	0	1	2	2	2	3
	Bank8	0	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0
	Bank2	0	0	0	0	0	0
	Bank3	0	0	0	0	0	0
	Bank4	19	32	46	50	46	54
	Bank5	18	17	46	68	46	68
	Bank6	0	0	0	0	0	0
	Bank7	0	0	0	0	0	0
	Bank8	0	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
138	PR15A	3	PCLKT3_0	T (LVDS)*	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*	
139	GND	-			GND	-			
140	VCC	-			VCC	-			
141	PR13B	2	PCLKC2_0/RDQ10	C	PR19B	2	PCLKC2_0/RDQ16	C	
142	PR13A	2	PCLKT2_0/RDQ10	T	PR19A	2	PCLKT2_0/RDQ16	T	
143	VCCIO2	2			VCCIO2	2			
144	PR12A	2	RDQ10		PR16A	2	RDQS16		
145	GND	-			GND	-			
146	VCC	-			VCC	-			
147	PR8B	2	RDQ10	C (LVDS)*	PR14B	2	RDQ16	C (LVDS)*	
148	VCCIO2	2			VCCIO2	2			
149	PR8A	2	RDQ10	T (LVDS)*	PR14A	2	RDQ16	T (LVDS)*	
150	PR6B	2	RDQ10	C (LVDS)*	PR12B	2	RDQ16	C (LVDS)*	
151	VCCAUX	-			VCCAUX	-			
152	PR6A	2	RDQ10	T (LVDS)*	PR12A	2	RDQ16	T (LVDS)*	
153	PR4B	2		C (LVDS)*	PR6B	2	RDQ8	C (LVDS)*	
154	PR4A	2		T (LVDS)*	PR6A	2	RDQ8	T (LVDS)*	
155	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*	
156	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*	
157	PT55B	1	VREF2_1	C	PT64B	1	VREF2_1	C	
158	PT55A	1	VREF1_1	T	PT64A	1	VREF1_1	T	
159	GND	-			GND	-			
160	PT54B	1		C	PT62B	1		C	
161	PT54A	1		T	PT62A	1		T	
162	VCCIO1	1			VCCIO1	1			
163	PT52B	1		C	PT60B	1		C	
164	PT52A	1		T	PT60A	1		T	
165	PT50B	1		C	PT58B	1		C	
166	PT50A	1		T	PT58A	1		T	
167	PT48B	1		C	PT56B	1		C	
168	PT48A	1		T	PT56A	1		T	
169	GND	-			GND	-			
170	VCCIO1	1			VCCIO1	1			
171	VCC	-			VCC	-			
172	PT40B	1		C	PT50B	1		C	
173	PT40A	1		T	PT50A	1		T	
174	VCCAUX	-			VCCAUX	-			
175	GND	-			GND	-			
176	PT36B	1		C	PT44B	1		C	
177	PT36A	1		T	PT44A	1		T	
178	PT34B	1		C	PT42B	1		C	
179	PT34A	1		T	PT42A	1		T	
180	PT30B	1	PCLKC1_0	C	PT39B	1	PCLKC1_0	C	
181	PT30A	1	PCLKT1_0	T	PT39A	1	PCLKT1_0	T	
182	XRES	1			XRES	1			
183	PT28B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C	

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P3	PL54B	7	LDQ54	C (LVDS)*
R6	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7		
R8	PL55B	7	LDQ54	C
P2	PL56A	7	LDQ54	T (LVDS)*
P1	PL56B	7	LDQ54	C (LVDS)*
R5	PL57A	7	PCLKT7_0/LDQ54	T
GND	GNDIO7	-		
R7	PL57B	7	PCLKC7_0/LDQ54	C
R4	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
R3	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
T5	PL60A	6	VREF2_6/LDQ63	T
T7	PL60B	6	VREF1_6/LDQ63	C
T3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
T4	PL61B	6	LDQ63	C (LVDS)*
T6	PL62A	6	LDQ63	T
T8	PL62B	6	LDQ63	C
T2	PL63A	6	LDQS63	T (LVDS)*
GND	GNDIO6	-		
T1	PL63B	6	LDQ63	C (LVDS)*
U7	PL64A	6	LDQ63	T
U5	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6		
U4	PL65A	6	LDQ63	T (LVDS)*
U3	PL65B	6	LDQ63	C (LVDS)*
U8	PL66A	6	LDQ63	T
U6	PL66B	6	LDQ63	C
GND	GNDIO6	-		
U2	PL67A	6	LDQ71	T (LVDS)*
U1	PL67B	6	LDQ71	C (LVDS)*
V7	PL68A	6	LDQ71	T
V5	PL68B	6	LDQ71	C
VCCIO	VCCIO6	6		
V2	PL69A	6	LDQ71	T (LVDS)*
V1	PL69B	6	LDQ71	C (LVDS)*
V8	PL70A	6	LDQ71	T
V6	PL70B	6	LDQ71	C
GND	GNDIO6	-		
W1	PL71A	6	LDQS71	T (LVDS)*
W2	PL71B	6	LDQ71	C (LVDS)*
W5	PL72A	6	LDQ71	T
VCCIO	VCCIO6	6		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AD2	PL90B	6	LDQ88	C (LVDS)*
AD7	PL91A	6	LDQ88	T
GND	GNDIO6	-		
AB9	PL91B	6	LDQ88	C
AD5	TCK	-		
AE7	TDI	-		
AD4	TMS	-		
AA9	TDO	-		
AD3	VCCJ	-		
AC8	PB2A	5	VREF2_5/BDQ6	T
AE8	PB2B	5	VREF1_5/BDQ6	C
AD8	PB3A	5	BDQ6	T
AF8	PB3B	5	BDQ6	C
AG7	PB4A	5	BDQ6	T
VCCIO	VCCIO5	5		
AH7	PB4B	5	BDQ6	C
AC9	PB5A	5	BDQ6	T
AE9	PB5B	5	BDQ6	C
AD9	PB6A	5	BDQS6	T
GND	GNDIO5	-		
AF9	PB6B	5	BDQ6	C
AB10	PB7A	5	BDQ6	T
AA10	PB7B	5	BDQ6	C
AJ7	PB8A	5	BDQ6	T
VCCIO	VCCIO5	5		
AK7	PB8B	5	BDQ6	C
AC10	PB9A	5	BDQ6	T
AE10	PB9B	5	BDQ6	C
AJ8	PB10A	5	BDQ6	T
GND	GNDIO5	-		
AK8	PB10B	5	BDQ6	C
AF6	PB11A	5	BDQ15	T
AF7	PB11B	5	BDQ15	C
AG5	PB12A	5	BDQ15	T
AH5	PB12B	5	BDQ15	C
AG6	PB13A	5	BDQ15	T
AH6	PB13B	5	BDQ15	C
VCCIO	VCCIO5	5		
AJ4	PB14A	5	BDQ15	T
AK4	PB14B	5	BDQ15	C
GND	GNDIO5	-		
AJ5	PB15A	5	BDQS15	T
AK5	PB15B	5	BDQ15	C

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
V23	PR70A	3	RDQ71	T
W27	PR69B	3	RDQ71	C (LVDS)*
W28	PR69A	3	RDQ71	T (LVDS)*
V26	PR68B	3	RDQ71	C
VCCIO	VCCIO3	3		
V24	PR68A	3	RDQ71	T
W29	PR67B	3	RDQ71	C (LVDS)*
W30	PR67A	3	RDQ71	T (LVDS)*
U25	PR66B	3	RDQ63	C
GND	GNDIO3	-		
U23	PR66A	3	RDQ63	T
V29	PR65B	3	RDQ63	C (LVDS)*
V30	PR65A	3	RDQ63	T (LVDS)*
U26	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3		
U24	PR64A	3	RDQ63	T
U27	PR63B	3	RDQ63	C (LVDS)*
U28	PR63A	3	RDQS63	T (LVDS)*
GND	GNDIO3	-		
T23	PR62B	3	RDQ63	C
T25	PR62A	3	RDQ63	T
U29	PR61B	3	RDQ63	C (LVDS)*
U30	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3		
T24	PR60B	3	VREF2_3/RDQ63	C
T26	PR60A	3	VREF1_3/RDQ63	T
T27	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
T28	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
R24	PR57B	2	PCLKC2_0/RDQ54	C
R26	PR57A	2	PCLKT2_0/RDQ54	T
GND	GNDIO2	-		
T29	PR56B	2	RDQ54	C (LVDS)*
T30	PR56A	2	RDQ54	T (LVDS)*
R23	PR55B	2	RDQ54	C
R25	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2		
R27	PR54B	2	RDQ54	C (LVDS)*
R28	PR54A	2	RDQS54	T (LVDS)*
P26	PR53B	2	RDQ54	C
GND	GNDIO2	-		
P24	PR53A	2	RDQ54	T
R29	PR52B	2	RDQ54	C (LVDS)*
R30	PR52A	2	RDQ54	T (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P25	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2		
P23	PR51A	2	RDQ54	T
P27	PR50B	2	RDQ54	C (LVDS)*
P28	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-		
VCCIO	VCCIO2	2		
N24	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
N26	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
N23	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
N25	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2		
P29	PR37B	2	RDQ37	C (LVDS)*
P30	PR37A	2	RDQS37	T (LVDS)*
M26	PR36B	2	RDQ37	C
GND	GNDIO2	-		
M24	PR36A	2	RDQ37	T
N29	PR35B	2	RDQ37	C (LVDS)*
N30	PR35A	2	RDQ37	T (LVDS)*
M25	PR34B	2	RDQ37	C
VCCIO	VCCIO2	2		
M23	PR34A	2	RDQ37	T
M27	PR33B	2	RDQ37	C (LVDS)*
M28	PR33A	2	RDQ37	T (LVDS)*
L26	PR32B	2	RDQ29	C
GND	GNDIO2	-		
L24	PR32A	2	RDQ29	T
M29	PR31B	2	RDQ29	C (LVDS)*
M30	PR31A	2	RDQ29	T (LVDS)*
L25	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2		
L23	PR30A	2	RDQ29	T
L27	PR29B	2	RDQ29	C (LVDS)*
L28	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-		
K24	PR28B	2	RDQ29	C
K26	PR28A	2	RDQ29	T
L29	PR27B	2	RDQ29	C (LVDS)*
L30	PR27A	2	RDQ29	T (LVDS)*
VCCIO	VCCIO2	2		
K23	PR26B	2	RDQ29	C
K25	PR26A	2	RDQ29	T
K27	PR25B	2	RDQ29	C (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
E21	PT76A	1		T
VCCIO	VCCIO1	1		
B22	PT75B	1		C
A22	PT75A	1		T
H20	PT74B	1		C
F21	PT74A	1		T
F20	PT73B	1		C
GND	GNDIO1	-		
H19	PT73A	1		T
D21	PT72B	1		C
C21	PT72A	1		T
E20	PT71B	1		C
VCCIO	VCCIO1	1		
G21	PT71A	1		T
B21	PT70B	1		C
A21	PT70A	1		T
F19	PT69B	1		C
G20	PT69A	1		T
E19	PT68B	1		C
GND	GNDIO1	-		
G19	PT68A	1		T
D20	PT67B	1		C
VCCIO	VCCIO1	1		
C20	PT67A	1		T
B20	PT66B	1		C
A20	PT66A	1		T
F18	PT65B	1		C
H18	PT65A	1		T
D19	PT64B	1		C
C19	PT64A	1		T
GND	GNDIO1	-		
G18	PT63B	1		C
E18	PT63A	1		T
H17	PT62B	1		C
F17	PT62A	1		T
VCCIO	VCCIO1	1		
G17	PT61B	1		C
E17	PT61A	1		T
B19	PT60B	1		C
A19	PT60A	1		T
GND	GNDIO1	-		
D17	PT59B	1		C
B18	PT59A	1		T

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A3	GND	-			GND	-		
A9	GND	-			GND	-		
B12	GND	-			GND	-		
B6	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		
R12	GND	-			GND	-		
R5	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
D10	NC	-			NC	-		
D11	NC	-			NC	-		
D12	NC	-			NC	-		
D13	NC	-			NC	-		
D14	NC	-			NC	-		
D4	NC	-			NC	-		
D5	NC	-			NC	-		
D6	NC	-			NC	-		
D7	NC	-			NC	-		
E11	NC	-			NC	-		
E6	NC	-			NC	-		
E8	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPPLLs or GDLLs within the respective quadrant.

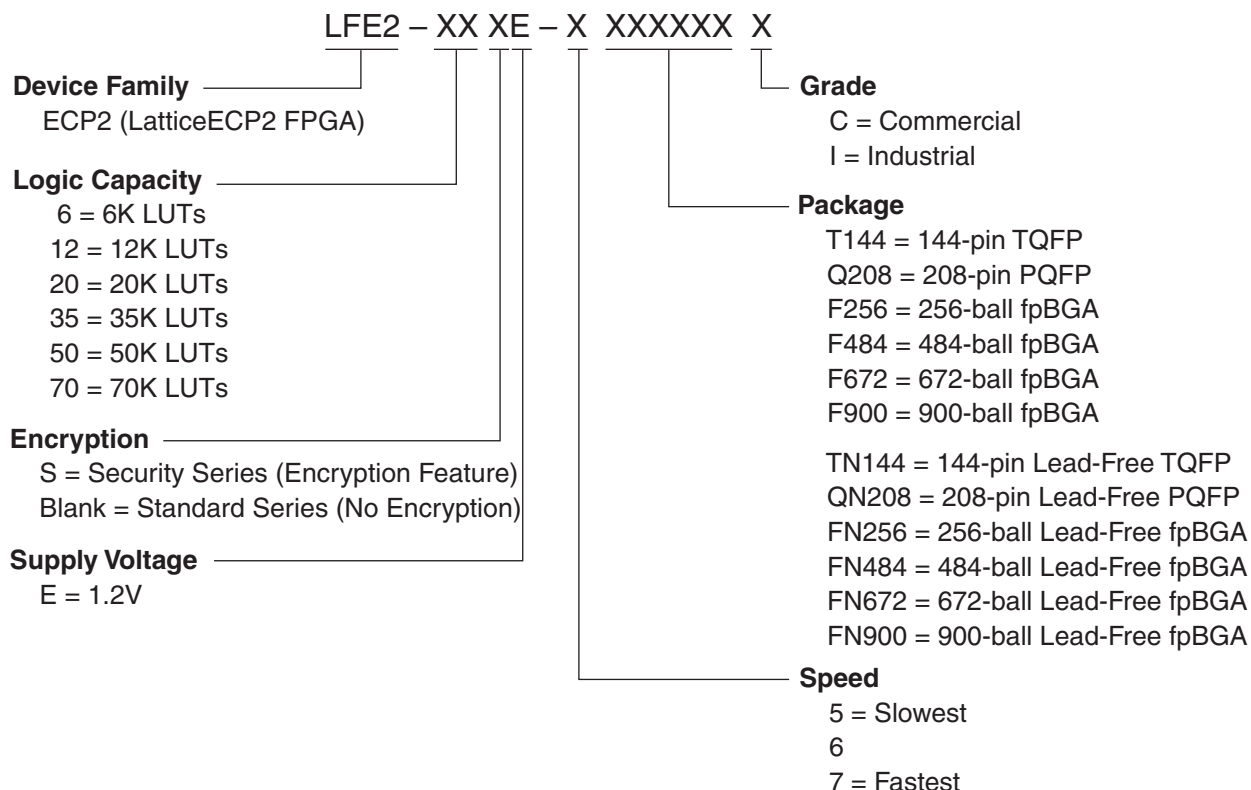
***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

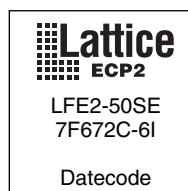
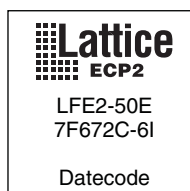
LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO7	7			VCCIO7	7		
F4	PL9A	7	VREF2_7	T	PL9A	7	VREF2_7	T
F3	PL9B	7	VREF1_7	C	PL9B	7	VREF1_7	C
GNDIO	GNDIO7	-			GNDIO7	-		
E1	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
E2	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*
K9	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
H7	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
VCCIO	VCCIO7	7			VCCIO7	7		
F1	PL13A	7	LDQ15	T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*
F2	PL13B	7	LDQ15	C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*
J8	PL14A	7	LDQ15	T	PL14A	7	LDQ15	T
H6	PL14B	7	LDQ15	C	PL14B	7	LDQ15	C
GNDIO	GNDIO7	-			GNDIO7	-		
G2	PL15A	7	LDQS15	T (LVDS)*	PL15A	7	LDQS15	T (LVDS)*
G1	PL15B	7	LDQ15	C (LVDS)*	PL15B	7	LDQ15	C (LVDS)*
J7	PL16A	7	LDQ15	T	PL16A	7	LDQ15	T
VCCIO	VCCIO7	7			VCCIO7	7		
L8	PL16B	7	LDQ15	C	PL16B	7	LDQ15	C
L9	PL17A	7	LDQ15	T (LVDS)*	PL17A	7	LDQ15	T (LVDS)*
L10	PL17B	7	LDQ15	C (LVDS)*	PL17B	7	LDQ15	C (LVDS)*
H5	PL18A	7	LDQ15	T	PL18A	7	LDQ15	T
GNDIO	GNDIO7	-			GNDIO7	-		
J6	PL18B	7	LDQ15	C	PL18B	7	LDQ15	C
H2	NC	-			PL19A	7	LDQ23	T (LVDS)*
H1	NC	-			PL19B	7	LDQ23	C (LVDS)*
G5	NC	-			PL20A	7	LDQ23	T
G6	NC	-			PL20B	7	LDQ23	C
M9	NC	-			PL21A	7	LDQ23	T (LVDS)*
-	-	-			VCCIO7	7		
M10	NC	-			PL21B	7	LDQ23	C (LVDS)*
H3	NC	-			PL22A	7	LDQ23	T
H4	NC	-			PL22B	7	LDQ23	C
J2	PL19A	7		T (LVDS)*	PL23A	7	LDQS23	T (LVDS)*
-	-	-			GNDIO7	-		
J1	PL19B	7		C (LVDS)*	PL23B	7	LDQ23	C (LVDS)*
K2	PL20A	7		T	PL24A	7	LDQ23	T
K1	PL20B	7		C	PL24B	7	LDQ23	C
VCCIO	VCCIO7	7			VCCIO7	7		
J4	PL21A	7		T (LVDS)*	PL25A	7	LDQ23	T (LVDS)*
J3	PL21B	7		C (LVDS)*	PL25B	7	LDQ23	C (LVDS)*
J5	PL22A	7		T	PL26A	7	LDQ23	T
K5	PL22B	7		C	PL26B	7	LDQ23	C
GNDIO	GNDIO7	-			GNDIO7	-		
L2	PL24A	7	LDQ28	T (LVDS)*	PL28A	7	LDQ32	T (LVDS)*
L1	PL24B	7	LDQ28	C (LVDS)*	PL28B	7	LDQ32	C (LVDS)*
L7	PL25A	7	LDQ28	T	PL29A	7	LDQ32	T
K6	PL25B	7	LDQ28	C	PL29B	7	LDQ32	C
VCCIO	VCCIO7	7			VCCIO7	7		

LatticeECP2 Part Number Description



Ordering Information

Note: LatticeECP2 devices are dual marked. For example, the commercial speed grade LFE2-50E-7F672C is also marked with industrial grade -6I (LFE2-50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:



Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2-35E-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2-35E-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2-35E-5FN672C	450	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2-35E-6FN672C	450	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2-35E-7FN672C	450	1.2V	-7	Lead-Free fpBGA	672	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5FN484C	339	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2-50E-6FN484C	339	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2-50E-7FN484C	339	1.2V	-7	Lead-Free fpBGA	484	COM	50
LFE2-50E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2-50E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2-50E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	70
LFE2-70E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	70
LFE2-70E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	70
LFE2-70E-5FN900C	583	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2-70E-6FN900C	583	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2-70E-7FN900C	583	1.2V	-7	Lead-Free fpBGA	900	COM	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5TN144I	90	1.2V	-5	Lead-Free TQFP	144	IND	6
LFE2-6E-6TN144I	90	1.2V	-6	Lead-Free TQFP	144	IND	6
LFE2-6E-5FN256I	190	1.2V	-5	Lead-Free fpBGA	256	IND	6
LFE2-6E-6FN256I	190	1.2V	-6	Lead-Free fpBGA	256	IND	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5TN144I	93	1.2V	-5	Lead-Free TQFP	144	IND	12
LFE2-12E-6TN144I	93	1.2V	-6	Lead-Free TQFP	144	IND	12
LFE2-12E-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	IND	12
LFE2-12E-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	IND	12
LFE2-12E-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	IND	12
LFE2-12E-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	IND	12
LFE2-12E-5FN484I	297	1.2V	-5	Lead-Free fpBGA	484	IND	12
LFE2-12E-6FN484I	297	1.2V	-6	Lead-Free fpBGA	484	IND	12